

LCP3121

Application Specific Discretes A.S.D.™

FEATURES AND BENEFITS

- UNIDIRECTIONAL OVERVOLTAGE SUP-PRESSOR PROGRAMMABLE BY VOLTAGE AND CURRENT:
- PROGRAMMABLE BREAKDOWN VOLTAGE UP TO 100 V.
- PROGRAMMABLE CURRENT LIMITATION FROM 120 mA TO 600 mA.
- MULTI-LINE PROTECTION MODE : ONE DE-VICE CAN PROTECT SEVERAL LINES.
- HIGH SURGE CURRENT CAPABILITY : IPP = 100A for 10/1000 μs.

DESCRIPTION

Dedicated to the protection of sensitive telecom equipment, the LCP3121 provides protection which can be programmed by both voltage and current.

The breakdown voltage can be easily programmed by using an external zener diode.

The protection function programmed by the current is achieved with the use of a resistor between the gate and the cathode. The value of the resistor will determine the level of the desired current before the triggering of the device.

A multiple protection mode is also performed when using several diodes providing each line interface with an optimized protection level.

If desired, a bidirectional protection function can be achieved by the use of two LCP3121.

COMPLIES WITH THE FOLLOWING STANDARDS :

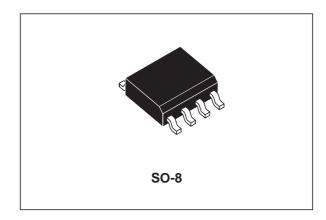
CCITT K20 :	10/700μs 5/310μs	6kV 150A
VDE 0433 :	10/700μs 5/310μs	2kV 50A
VDE 0878 :	1.2/50μs 1/20μs	1.5kV 40A
FCC part 68 :	2/10μs 2/10μs	2.5kV 200A (*)
BELLCORE	2/10μ3	2007()
TR-NWT-001089 :	2/10μs 2/10μs	2.5kV 200A (*)
BELLCORE	_,	
TR-NWT-000974 :	10/1000μs 10/1000μs	1kV 100A
(*) with series resistors or PTC.		

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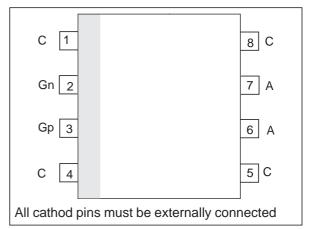
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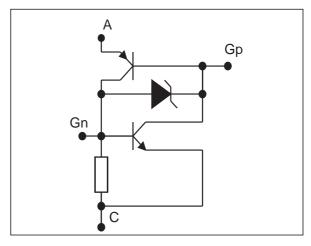
OVERVOLTAGE AND OVERCURRENT PROTECTION FOR TELECOM LINE



PIN-OUT CONFIGURATION



FUNCTIONAL DIAGRAM



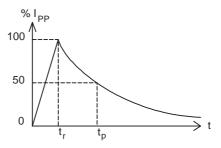
ABSOLUTE MAXIMUM RATINGS ($T_{amb} = 25^{\circ}C$)

Symbol	Parameter	Value	Unit	
I _{PP}	Peak pulse current (see note 1) 10/1000µs		100	А
I _{TSM}	Non repetitive surge peak on-state current $t_p = 10ms$ $(F = 50 Hz)$ $t = 1s$		16 8	A
V _{AC} V _{GA}	Maximum voltage between A and C Maximum voltage between G (Gn or Gp) and A	100 80	V	
T _{stg} Tj	Storage temperature range Maximum junction temperature	- 40 to + 150 150	°C	
ΤL	Maximum lead temperature for soldering during 1	260	°C	

Note 1 : Pulse waveform :

10/1000μs t_r=10μs

tp=1000μs

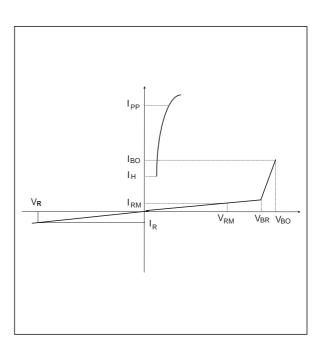


THERMAL RESISTANCE

Symbol	Parameter	Value	Unit
R _{th (j-a)}	Junction to ambient	170	°C/W

ELECTRICAL CHARACTERISTICS (T_{amb} = 25°C)

Symbol	Parameter	
V _{RM}	Stand-off voltage	
V _{BR}	Breakdown voltage	
V _{BO}	Breakover voltage	
Iн	Holding current	
I _{BO}	Breakover current	
I _{RM}	Leakage current at V _{RM}	
I _R	Leakage current at V _R	
IPP	Peak pulse current	
VR	Continuous reverse voltage	
Coff	Off-state capacitance	
VG	Gate voltage	
I _{GP}	Gp triggering current	
I _{GN}	Gn triggering current	



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1 - OPERATION WITHOUT GATE $(T_{amb} = 25 \text{ °C})$

Sym- bol	Test conditions	Min.	Max.	Unit
I _{RM}	$V_{RM} = 60V$ $V_{RM} = 90V$		5 8	μA
I _R	at VR = 180V		50	μA
V _{BR}	at 1mA	100		V
I _{BO}		80	500	mA
V _{BO}	Measured at 50Hz		180	V
Ι _Η	See the functional test circuit	100		mA

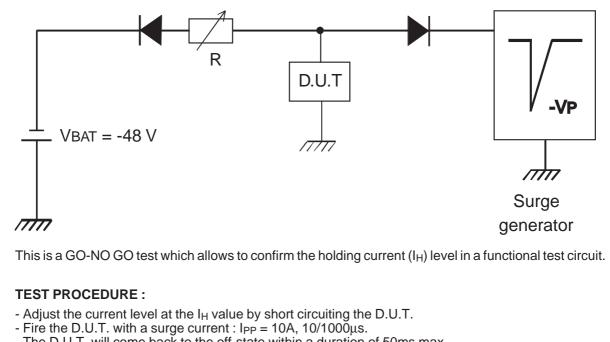
2 - OPERATION WITH GATE (Tamb = 25 °C)

Symbol	Test conditions	Min.	Max.	Unit
V _G (note1)	$I_{GATE} = 200 \text{mA}$ (for eigher Gn or Gp)	0.6	1.8	V
I _{GP}	V _{Anode-cathode} = 60V		180	mA
I _{GN}	V _{Anode-cathode} = 60V	80	200	mA

Note 1 : $V_G = V_{GN}$, measured between Gn and cathode $V_G = V_{GP}$, measured between Gp and anode

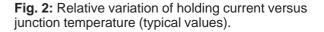
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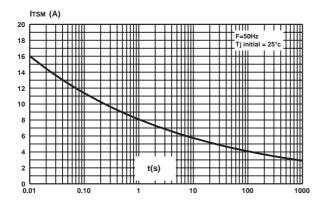
FUNCTIONAL HOLDING CURRENT (IH) TEST CIRCUIT : GO-NO GO TEST

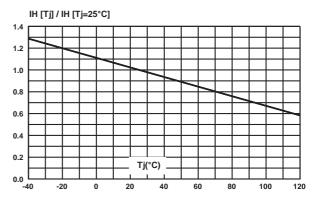


- The D.U.T. will come back to the off-state within a duration of 50ms max.

Fig. 1: Maximum non repetitive surge peak-on-state current versus overload duration.



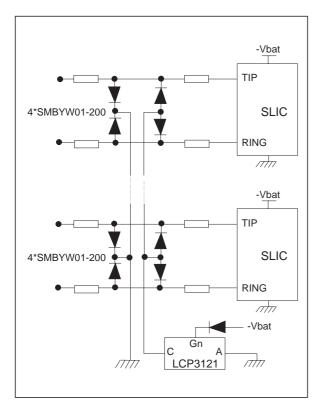




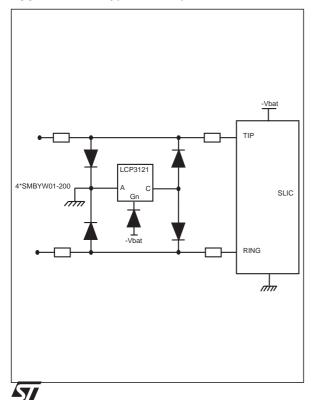
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APPLICATION EXAMPLES

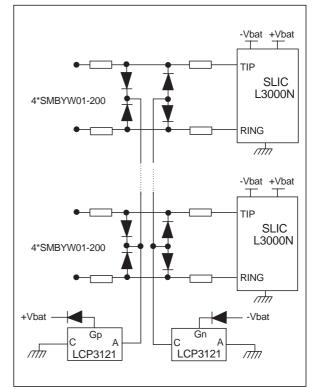
Application 1: Common protection for SLIC without integrated ring generator



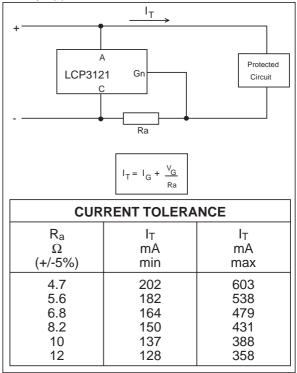
Application 3: Typical SLIC protection



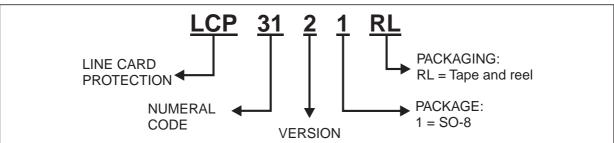
Application 2: Common protection for SLIC with integrated ring generator



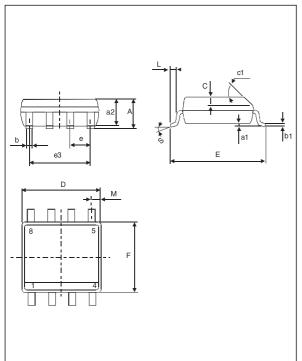
Application 4: Protection programmed by curren	t
for any application	



ORDER CODE



PACKAGE MECHANICAL DATA SO-8 Plastic



	DIMENSIONS					
REF.	Millimetres		Inches			
	Min.	Тур.	Max.	Min.	Тур.	Max.
А			1.75			0.069
a1	0.1		0.25	0.004		0.010
a2			1.65			0.065
b	0.35		0.48	0.014		0.019
b1	0.19		0.25	0.007		0.010
С		0.50			0.020	
c1	45° (typ)					
D	4.8		5.0	0.189		0.197
Е	5.8		6.2	0.228		0.244
е		1.27			0.050	
e3		3.81			0.150	
F	3.8		4.0	0.15		0.157
L	0.4		1.27	0.016		0.050
М			0.6			0.024
S	8° (max)					

MARKING

Package	Туре	Marking
SO-8	LCP3121	CP3121

Weight = 0.08 g

Packaging : Products supplied in anti-static tubes or tape and reel.

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